| IPC ASSOCIATION ELECTRONIC | © Copyright 2005. | Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All right international and Pan-American copyright conventions | | | This document is a declaration of the substances within the manuler both level parts, the declaration encompasses all lower level materials | | | | | | | | | | |
|---------------------------------------|---|---|---------------------------|----------------|---|--|---------------------|--|-----------|-------------------------|---------------------------------|----------------|-----------|-----------------|-----------|
| 752-21.1 | IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute | | | | * | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater | | | | | ials and Mfg Information | | | | |
| upplier | r Information | | | | | | | | | | | | | | |
| Company name* | | | Company unique ID | | | U | Unique ID Authority | | | | | Response Date* | | | |
| onsemi | | | | | | | | | | | | 2024-04-25 | | | |
| ontact N | Jame | Title - Contact | | | P | Phone - Contact* | | | | | Email - Contact* | | | | |
| roduct-F | Env-Stewards | Product Enviro Compliance | | | 1 | NA | | | | | Product-Env-Stewards@onsemi.com | | | | |
| uthorize | ed Representative* | Title - Representative | | | P | Phone - Representative* | | | | Email - Representative* | | | | | |
| Product-Env-Stewards | | | Product Enviro Compliance | | | I | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| | Requester Item Number | Mfr Item | n Number | Mfr Item Name | | | Effective Date | Version | n | Manufacturing Site | | V | Veight* | UOM | Unit Type |
| | | FNA21012A IPM SPM34 12 | | IPM SPM34 1200 | V 10A | 10A 2024-04 | | | | CPA | | 4 | 9614.715 | mg | Each |
| lanufa | cturing Process Inform | | Terminal Base | Alloy | -STD-020 MSI | Pating | Peak Proc | ess Rody | Temperatu | re May Time | at Peak | Temperati | ure Numbe | r of Reflow Cyo | cles |
| , , , , , , , , , , , , , , , , , , , | | CU Allov NA | | | 2 Kating | 0 | | S Body Temperature Max Time at Peak C 30 | | seconds 3 | | I of Kellow Cy | cies | | |
| omments | . , | | COTINO | | 1/1 | | Į v | | | 150 | | Second | 10 0 | | |
| minents | , | | | | | | | | | | | | | | |
| ar mare i | information regarding materia | al composition | nlease refer to | n nage 3 | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | Declaration Type * | Detailed | | | | | | | |
|--|--|--|---|--|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). | | | | | | | | | | | |
| Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply. | | | | | | | | | | | |
| RoHS Declaration * 4 - Item(s |) does not contain RoHS restricted substance | s per the definition above except for selected exemp | otions Supplier Acceptance | * Accepted | | | | | | | |
| Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). | | | | | | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | | |
| Declaration Signature | | | | | | | | | | | |
| Instructions: Complete all of the required f Requester) and click on Submit Form to ha | | Accepted" on the Supplier Acceptance drop-dow | n. This will display the signature area. Digita | lly sign the declaration (if required by the | | | | | | | |
| Supplier Digital Signature Ra | astislav Drska | -En | | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|---------|-----------------|----------|------------------------------|------------|--------|------------|-----------------|
| Die | | | Supplier | Silicon (Si) | 7440-21-3 | | 104.6 | mg |
| Die Attach | 195.0 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 5.85 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 188.175 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.975 | mg |
| Die Attach Epoxy | 1.85 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 1.702 | mg |
| | | | Supplier | Phenolic Resin-2 | 54208-63-8 | | 0.148 | mg |
| Die Attach Solder | 1.7 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.0425 | mg |
| | | | A | Lead (Pb) | 7439-92-1 | 7a | 1.5725 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 0.085 | mg |
| Heat Sink | 6642.0 | mg | Supplier | Aluminum (Al) | 7429-90-5 | | 6642 | mg |
| Lead Frame | 11022.5 | mg | Supplier | Iron (Fe) | 7439-89-6 | | 16.5338 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 11000.4551 | mg |
| | | | Supplier | Phosphorus (P) | 7723-14-0 | | 5.5103 | mg |
| Mold Compound-Black | 31430.0 | mg | Supplier | Ortho Cresol Novolac Resin | 29690-82-2 | | 1571.5 | mg |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 314.3 | mg |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 27972.6992 | mg |
| | | | Supplier | Phenolic Resin (Novolac) | 9003-35-4 | | 1571.5 | mg |
| Plating | 106.6 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 106.6 | mg |
| Thermistor | 10.0 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.8 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 0.17 | mg |
| | | | Supplier | Nickel Oxide (NiO) | 1313-99-1 | | 2.6 | mg |
| | | | Supplier | Palladium (Pd) | 7440-05-3 | | 0.35 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.08 | mg |
| | | | Supplier | Cobalt Oxide (Co3O4) | 1308-06-1 | | 1.7 | mg |
| | | | Supplier | Manganese Tetraoxide (Mn3O4) | 1317-35-7 | | 4.3 | mg |
| Wire Bond - Al | 100.0 | mg | Supplier | Aluminum (Al) | 7429-90-5 | | 100 | mg |
| Wire Bond - Cu | 0.463 | mg | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0093 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 0.4537 | mg |